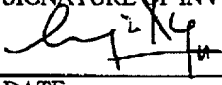


ATTORNEY'S DOCKET NO.
TI-33486

APPLICATION FOR UNITED STATES PATENT
DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I declare that my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor if only one name is listed below, or an original, first and joint inventor if plural inventors are named below, of the subject matter which is claimed and for which a patent is sought on the invention entitled as set forth below, which is described in the attached specification; that I have reviewed and understand the contents of the specification, including the claims, as amended by any amendment specifically referred to in the oath or declaration; that no application for patent or inventor's certificate on this invention has been filed by me or my legal representatives or assigns in any country foreign to the United States of America; and that I acknowledge my duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, section 1.56(a);

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

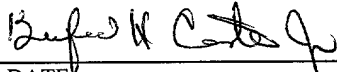
TITLE OF INVENTION:		IMPROVED PCB SOLDER PAD GEOMETRY INCLUDING PATTERNS IMPROVING SOLDER COVERAGE	
POWER OF ATTORNEY:		I HEREBY APPOINT THE FOLLOWING ATTORNEYS TO PROSECUTE THIS APPLICATION AND TRANSACT ALL BUSINESS IN THE PATENT AND TRADEMARK OFFICE CONNECTED THEREWITH Customer Number: 23494	
SEND CORRESPONDENCE TO: Mike Skrehot Texas Instruments Incorporated P. O. Box 655474, M/S 3999 Dallas, Texas 75265		DIRECT TELEPHONE CALLS TO: Mike Skrehot 972-917-5653	
NAME OF INVENTOR: (1) Wee Lee Ng	NAME OF INVENTOR: (2) Buford Carter	NAME OF INVENTOR: (3)	
RESIDENCE (City and State Only) Richardson, Texas	RESIDENCE (City and State Only) Richardson, Texas 75080	RESIDENCE (City and State Only)	
POST OFFICE ADDRESS 540 Buckingham Road # 1337 Richardson, Texas	POST OFFICE ADDRESS 902 Pinecrest Drive Richardson, Texas 75080	POST OFFICE ADDRESS	
COUNTRY OF CITIZENSHIP: Malaysia	COUNTRY OF CITIZENSHIP: USA	COUNTRY OF CITIZENSHIP:	
SIGNATURE OF INVENTOR: 	SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:	
DATE: 1/31/2002	DATE:	DATE:	

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NAME OF INVENTOR: (1)	NAME OF INVENTOR: (2)	NAME OF INVENTOR: (3)	
Wee Lee Ng	Buford H. Carter Jr.		
RESIDENCE (City and State Only)	RESIDENCE (City and State Only)	RESIDENCE (City and State Only)	
Richardson, Texas	Richardson, Texas 75080		
POST OFFICE ADDRESS	POST OFFICE ADDRESS	POST OFFICE ADDRESS	
540 Buckingham Road # 1337 Richardson, Texas	902 Pinecrest Drive Richardson, Texas 75080		
COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:	COUNTRY OF CITIZENSHIP:	
Malaysia	USA		
SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:	SIGNATURE OF INVENTOR:	
			
DATE:	DATE:	DATE:	
	1-31-02		